



**THS7327** 

SLOS502-SEPTEMBER 2006

# 3-Channel RGBHV Video Buffer with I<sup>2</sup>C Control, Selectable Filters, Monitor Pass-Thru, 2:1 Input MUX, and Selectable Input Bias Modes

#### **FEATURES**

- 3-Video Amplifiers for CVBS, S-Video, SD/ED/HD Y'P'<sub>B</sub>P'<sub>R</sub>, G'B'R', and R'G'B' Video
- HV Sync Paths With Adj. Schmitt Trigger
- 2:1 Input MUX
- I<sup>2</sup>C™ Control of All Functions
- Integrated Low-Pass Filters on ADC Buffers
  - 5<sup>th</sup> Order Butterworth Characteristics
  - Selectable Corner Frequencies of 9-MHz, 16-MHz, 35-MHz, and 75-MHz with Bypass (500-MHz)
- Selectable Input Bias Modes
  - AC-Coupled with Sync-Tip Clamp
  - AC-Coupled with Bias
  - DC-Coupled with Offset Shift
  - DC-Coupled
- Monitor Pass-Thru Function:
  - Passes the Input Signal With no Filtering
  - 500-MHz BW and 1300 V/μs Slew Rate
  - 6-dB Gain With SAG Correction Capable
  - High Output Impedance in Disable State
- 2.7-V to 5-V Single Supply Operation
- Low 330 mW at 3.3-V Power Consumption
- Disable Function Reduces Current to <1 μA</li>

- Rail-to-Rail Output:
- Output Swings Within 0.1 V From the Rails
   Which Allows AC or DC Output Coupling
- RoHS TQFP Package

#### **APPLICATIONS**

- Projectors
- Professional Video Systems
- LCD/DLP/LOCS Input Buffering

#### DESCRIPTION

Fabricated using complimentary silicon-germanium (SiGe) BiCom-III process, the THS7327 is a low-power, single-supply 2.7-V to 5-V, 3-channel integrated video buffer with H and V Sync signal paths. It incorporates a selectable 5th order Butterworth anti-aliasing filter on each channel. The 9-MHz is a perfect choice for SDTV video including composite, S-Video™, and 480i/576i. The 16-MHz filter is ideal for EDTV 480p/576p, and VGA signals. The 35-MHz filter is useful for HDTV 720p/1080i, and SVGA signals. The 75-MHz filter is ideal for HDTV 1080p and XGA/SXGA signals. For UXGA/QXGA R'G'B' signals, the filter can be bypassed allowing a 500-MHz bandwidth, 1150-V/us amplifier to buffer the signal.

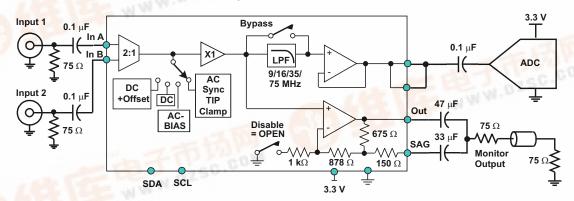


Figure 1. 3.3 V Single-Supply AC-Input/AC-Video Output System w/SAG Correction (1 of 3 Channels Shown)

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### **DESCRIPTION (CONTINUED)**

Each channel of the THS7327 is individually  $I^2C$  configurable for all functions including controlling the 2:1 input MUX. Its rail-to-rail output stage allows for both ac and dc coupling applications. The monitor pass-thru path allows for passing the input signal, with no filtering, on to other systems. This path has a 6-dB Gain, 500-MHz bandwidth,  $1300V/\mu s$  slewrate, SAG correction capability, and a high output impedance while disabled to add to the flexibility of the THS7327.

As part of the THS7327's flexibility, the input can be selected for ac or dc coupled inputs. The ac-coupled modes include a sync-tip clamp option for CVBS/Y'/G'B'R' with sync or a fixed bias for the C'/P'<sub>B</sub>/P'<sub>R</sub>/R'G'B' channels without sync. The dc input options include a dc input or a dc+Offset shift to allow for a full sync dynamic range at the output with 0-V input.

The THS7327 is available in a RoHS Compliant TQFP package.

#### PACKAGING/ORDERING INFORMATION

| PACKAGED DEVICES(1) | PACKAGE TYPE         | TRANSPORT MEDIA, QUANTITY |
|---------------------|----------------------|---------------------------|
| THS7327PHP          | LITOED 40 DowerDADIM | Tray 250                  |
| THS7327PHPR         | HTQFP-48 PowerPAD™   | Tape and reel, 1000       |

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com

#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                |   | UNIT                         |
|------------------|----------------|---|------------------------------|
| V <sub>SS</sub>  | Supply voltage | e, V <sub>S+</sub> to GND   | 5.5 V                        |
| VI               | Input voltage  |   | -0.4 V to V <sub>S+</sub>    |
| Io               | Output current |   | ±100 mA                      |
|                  | Continuous po  | wer dissipation   | See Dissipation Rating Table |
| $T_{J}$          | Maximum junc   | tion temperature, any condition (2)                               | 150°C                        |
| $T_{J}$          | Maximum junc   | tion temperature, continuous operation, long term reliability (3) | 125°C                        |
| T <sub>stg</sub> | Storage tempe  | erature range   | −65°C to 150°C               |
|                  |                | НВМ   | 1500 V                       |
|                  | ESD ratings    | CDM   | 1500 V                       |
|                  |                | MM  | 100 V                        |

<sup>(1)</sup> Stresses above those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied Exposure to absolute maximum rated conditions for extended periods may degrade device reliability.

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 <sup>(2)</sup> The absolute maximum junction temperature under any condition is limited by the constraints of the silicon process.
 (3) The absolute maximum junction temperature for continuous operation is limited by the package constraints. Operation above this temperature may result in reduced reliability and/or lifetime of the device.



#### **DISSIPATION RATINGS**

| PACKAGE                   | θ <sub>JC</sub><br>(° <b>C/W</b> ) | θ <sub>JA</sub><br>(°C/W) | POWER RATING <sup>(1)(2)</sup><br>(T <sub>J</sub> = 125°C) |                       |  |  |
|---------------------------|------------------------------------|---------------------------|--|-----------------------|--|--|
|                           | ( C/VV)                            | ( C/VV)                   | T <sub>A</sub> = 25°C                                      | T <sub>A</sub> = 85°C |  |  |
| HTQFP-48 w/PowerPAD (PHP) | 1.1                                | 35                        | 2.85 W   | 1.14 W                |  |  |

<sup>(1)</sup> This data was taken with a PowerPAD standard 3 inch by 3 inch, 4-layer PCB with internal ground plane connections to the PowerPAD.

#### RECOMMENDED OPERATING CONDITIONS

|          |                                 | MIN | NOM | MAX | UNIT |
|----------|---------------------------------|-----|-----|-----|------|
| $V_{SS}$ | Supply voltage, V <sub>S+</sub> | 2.7 |     | 5   | V    |
| $T_A$    | Ambient temperature             | -40 |     | 85  | Ô    |

## ELECTRICAL CHARACTERISTICS, $V_A = V_{DD} = 3.3 \text{ V}$

 $R_L$  = 150  $\Omega$  || 5 pF to GND for Monitor Output, 19 k $\Omega$  || 8 pF Load to GND for ADC Buffer, ADC Buffer Filter = 9 MHz, SAG pin shorted to Monitor Output Pin (unless otherwise noted)

|                         |                                  |  | TYP  | OVER TEMPERATURE |                |                  |       |         |  |
|-------------------------|----------------------------------|--|------|------------------|----------------|------------------|-------|---------|--|
| PARAME                  | TER                              | TEST CONDITIONS 25°C                                       |      | 25°C             | 0°C to<br>70°C | –40°C to<br>85°C | UNITS | MIN/MAX |  |
| AC PERFORMANCE          |                                  |  |      |                  |                |                  |       |         |  |
|                         |                                  | Filter Select = 9 MHz <sup>(1)</sup>                       | 9    | 7/10.4           | 6.9/10.5       | 6.8/10.5         | MHz   | Min/Max |  |
|                         |                                  | Filter Select = 16 MHz <sup>(1)</sup>                      | 16   | 13.1/9.6         | 12.9/19.7      | 12.8/19.7        | MHz   | Min/Max |  |
| Small-signal bandwidth  | Buffer Output $V_O = 0.2 V_{PP}$ | Filter Select = 35 MHz <sup>(1)</sup>                      | 35   | 28/40.5          | 27.8/41.3      | 27.7/41.3        | MHz   | Min/Max |  |
| (-3 dB)                 | 10 41- 175                       | Filter Select = 75 MHz <sup>(1)</sup>                      | 75   | 61/86.8          | 60.5/90.3      | 60.4/90.3        | MHz   | Min/Max |  |
|                         |                                  | Filter Select = Bypass                                     | 500  |                  |                |                  | MHz   | Тур     |  |
|                         | MonitorOutput                    |  | 450  |                  |                |                  | MHz   | Тур     |  |
|                         |                                  | Filter Select = 9 MHz                                      | 9    |                  |                |                  | MHz   | Тур     |  |
|                         |                                  | Filter Select = 16 MHz                                     | 16   |                  |                |                  | MHz   | Тур     |  |
| Large-signal bandwidth  | Buffer Output $V_O = 1 V_{PP}$   | Filter Select = 35 MHz                                     | 35   |                  |                |                  | MHz   | Тур     |  |
| (–3 dB)                 | VO = 1 VPP                       | Filter Select = 75 MHz                                     | 75   |                  |                |                  | MHz   | Тур     |  |
|                         |                                  | Filter Select = Bypass                                     | 500  |                  |                |                  | MHz   | Тур     |  |
|                         | Monitor Output                   | V <sub>O</sub> = 2 V <sub>PP</sub>                         | 300  |                  |                |                  | MHz   | Тур     |  |
| Slew rate               | Buffer Output                    | Filter Select = Bypass: V <sub>O</sub> = 1 V <sub>PP</sub> | 1050 |                  |                |                  | V/µs  | Тур     |  |
|                         | Monitor Output                   | V <sub>O</sub> = 2 V <sub>PP</sub>                         | 1050 |                  |                |                  | V/µs  | Тур     |  |
|                         |                                  | Filter Select = 9 MHz                                      | 56   |                  |                |                  | ns    | Тур     |  |
|                         |                                  | Filter Select = 16 MHz                                     | 31   |                  |                |                  | ns    | Тур     |  |
| O deleve et 400 bille   | Buffer Output                    | Filter Select = 35 MHz                                     | 16   |                  |                |                  | ns    | Тур     |  |
| Group delay at 100 kHz  |                                  | Filter Select = 75 MHz                                     | 8    |                  |                |                  | ns    | Тур     |  |
|                         |                                  | Filter Select = Bypass                                     | 1.3  |                  |                |                  | ns    | Тур     |  |
|                         | Monitor Output                   |  | 1.3  |                  |                |                  | ns    | Тур     |  |
|                         |                                  | Filter Select = 9 MHz: at 5.1 MHz                          | 10.5 |                  |                |                  | ns    | Тур     |  |
| Group delay variation   | D. # O. I I                      | Filter Select = 16 MHz: at 11 MHz                          | 7.2  |                  |                |                  | ns    | Тур     |  |
| with respect to 100 kHz | Buffer Output                    | Filter Select = 35 MHz: at 27 MHz                          | 4    |                  |                |                  | ns    | Тур     |  |
|                         |                                  | Filter Select = 75 MHz: at 54 MHz                          | 2    |                  |                |                  | ns    | Тур     |  |
|                         |                                  | Filter Select = 9 MHz: at 5.75 MHz                         | 0.4  | -0.3/1.5         | -0.35/1.55     | -0.4/1.6         | dB    | Min/Max |  |
|                         |                                  | Filter Select = 9 MHz: at 27 MHz                           | 39   | 31               | 30.5           | 30               | dB    | Min     |  |
|                         |                                  | Filter Select = 16 MHz: at 11 MHz                          | 0.5  | -0.3/1.5         | -0.35/1.55     | -0.4/1.6         | dB    | Min/Max |  |
| Attenuation with        | D # O + -                        | Filter Select = 16 MHz: at 54 MHz                          | 40   | 32               | 31.5           | 31               | dB    | Min     |  |
| respect to 100 kHz      | Buffer Output                    | Filter Select = 35 MHz: at 27 MHz                          | 1    | -0.3/2.7         | -0.35/2.75     | -0.4/2.8         | dB    | Min/Max |  |
|                         |                                  | Filter Select = 35 MHz: at 74 MHz                          | 27   | 19               | 18.5           | 18               | dB    | Min     |  |
|                         |                                  | Filter Select = 75 MHz: at 54 MHz                          | 0.6  | -0.3/1.8         | -0.4/1.9       | -0.45/2          | dB    | Min/Max |  |
|                         |                                  | Filter Select = 75 MHz: at 148 MHz                         | 25   | 17               | 16.5           | 16               | dB    | Min     |  |

(1) The Min/Max values listed are specified by design only.

<sup>2)</sup> Power rating is determined with a junction temperature of 125°C. This is the point where distortion starts to substantially increase and long-term reliability starts to be reduced. Thermal management of the final PCB should strive to keep the junction temperature at or below 125°C for best performance and reliability.



## ELECTRICAL CHARACTERISTICS, $V_A = V_{DD} = 3.3 \text{ V}$ (continued)

 $R_L$  = 150  $\Omega$  || 5 pF to GND for Monitor Output, 19 k $\Omega$  || 8 pF Load to GND for ADC Buffer, ADC Buffer Filter = 9 MHz, SAG pin shorted to Monitor Output Pin (unless otherwise noted)

|                          |   | TYP                                   |           |           | OVI            | /ER TEMPERATURE  |       |         |
|--------------------------|---|---------------------------------------|-----------|-----------|----------------|------------------|-------|---------|
| PARAME                   | ETER  | TEST CONDITIONS                       | 25°C      | 25°C      | 0°C to<br>70°C | –40°C to<br>85°C | UNITS | MIN/MAX |
| Differential gain        | Buffer Output                                       | Filter Select = 9 MHz: NTSC/PAL       | 0.3/0.45  |           |                |                  | %     | Тур     |
|                          | Monitor Output                                      | NTSC/PAL                              | 0.07/0.08 |           |                |                  | %     | Тур     |
| Differential phase       | Buffer Output                                       | Filter Select = 9 MHz: NTSC/PAL       | 0.45/0.5  |           |                |                  | 0     | Тур     |
| Differential phase       | Monitor Output                                      | NTSC/PAL                              | 0.07/0.08 |           |                |                  | 0     | Тур     |
|                          |   | Filter Select = 9 MHz                 | -61       |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = 16 MHz                | -60       |           |                |                  | dB    | Тур     |
| Total harmonic           | Buffer Output<br>V <sub>O</sub> = 1 V <sub>PP</sub> | Filter Select = 35 MHz                | -57       |           |                |                  | dB    | Тур     |
| distortion<br>f = 1 MHz, | 10 - 1 175  | Filter Select = 75 MHz                | -55       |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = Bypass                | -60       |           |                |                  | dB    | Тур     |
|                          | Monitor Output                                      | V <sub>O</sub> = 2 V <sub>PP</sub>    | -60       |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = 9 MHz                 | 80        |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = 16 MHz                | 77        |           |                |                  | dB    | Тур     |
| Signal to noise ratio    | Buffer Output                                       | Filter Select = 35 MHz                | 75        |           |                |                  | dB    | Тур     |
| (unified weighting)      |   | Filter Select = 75 MHz                | 73        |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = Bypass <sup>(2)</sup> | 66        |           |                |                  | dB    | Тур     |
|                          | Monitor Output                                      | See (2)                               | 71        |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = 9 MHz: at 5 MHz       | -58       |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = 16 MHz: at 10 MHz     | -65       |           |                |                  | dB    | Тур     |
| Channel-to-Channel       | Buffer Output                                       | Filter Select = 35 MHz: at 27 MHz     | -58       |           |                |                  | dB    | Тур     |
| Crosstalk                | Danier Garpar                                       | Filter Select = 75 MHz: at 60 MHz     | -58       |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = Bypass: at 100 MHz    | -47       |           |                |                  | dB    | Тур     |
|                          | Monitor Output                                      | F = 100 MHz                           | -35       |           |                |                  | dB    | Тур     |
|                          | Worldon Output                                      | Filter Select = 9 MHz: at 5.5 MHz     | 65        |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = 16 MHz: at 11 MHz     | 65        |           |                |                  | dB    |         |
| MIIV location            | Buffer Output                                       |                                       |           |           |                |                  |       | Тур     |
| MUX Isolation            |   | Filter Select = 35 MHz: at 27 MHz     | 65        |           |                |                  | dB    | Тур     |
|                          |   | Filter Select = Bypass: at 60 MHz     | 65        |           |                |                  | dB    | Тур     |
|                          | Monitor Output                                      | f = 100 MHz                           | 66        |           |                |                  | dB    | Тур     |
| Gain                     | Buffer Output                                       | f = 100 kHz; V <sub>O</sub> = 1Vpp    | 0         | 5.0/0.05  | 5.75/0.0       | 5 75 /0 05       | dB    | Тур     |
|                          | Monitor Output                                      | f = 100 kHz; V <sub>O</sub> = 2Vpp    | 6         | 5.8/6.25  | 5.75/6.3       | 5.75/6.35        | dB    | Min/Max |
| Settling time            | Buffer Output                                       | Vin = 1 Vpp; 0.5% Settling            | 6         |           |                |                  | ns    | Тур     |
|                          | Monitor Output                                      |                                       | 6         |           |                |                  | ns    | Тур     |
| Output impedance         | Buffer Output                                       | f = 10 MHz                            | 2         |           |                |                  | Ω     | Тур     |
|                          | Monitor Output                                      | f = 10 MHz                            | 0.4       |           |                |                  | Ω     | Тур     |
| DC PERFORMANCE           | T   |                                       |           | T         |                |                  | 1     |         |
| Output offset voltage    | Buffer Output                                       | Bias = dc, Filter = 16 MHz            | 65        | 130       | 135            | 135              | mV    | Max     |
|                          | Monitor Output                                      | Bias = dc                             | 20        | 90        | 95             | 95               | mV    | Max     |
| Average offset voltage   | Buffer Output                                       | Bias = dc                             |           |           |                | 20               | μV/°C | Тур     |
| drift                    | Monitor Output                                      | Bias = dc                             |           |           |                | 20               | μV/°C | Тур     |
|                          | Buffer Output                                       | Bias = dc + Shift, Vin = 0 V          | 340       | 260/410   | 250/420        | 240/430          | mV    | Min/Max |
| Pice output voltage      | Bullet Output                                       | Bias = ac                             | 1.1       | 0.95/1.25 | 0.9/1.3        | 0.9/1.3          | V     | Min/Max |
| Bias output voltage      | Manitan Output                                      | Bias = dc + Shift, Vin = 0 V          | 230       | 160/325   | 155/345        | 150/350          | mV    | Min/Max |
|                          | Monitor Output                                      | Bias = ac                             | 1.7       | 1.55/1.85 | 1.5/1.9        | 1.5/1.9          | V     | Min/Max |
| Owner the state of       | Buffer Output                                       | Bina as OTO slaves "                  | 345       | 260/430   | 255/435        | 250/440          | mV    | Min/Max |
| Sync tip clamp voltage   | Monitor Output                                      | Bias = ac STC, clamp voltage          | 305       | 210/400   | 205/405        | 200/410          | mV    | Min/Max |
| Input bias current       | •   | Bias = dc - implies lb out of the pin | -1.4      | -3        | -3.5           | -3.5             | μА    | Max     |
| Average bias current dri | ft  | Bias = dc                             |           |           |                | 10               | nA/°C | Тур     |
|                          |   | Bias = ac STC, low bias               | 2.3       | 0.9/3.5   | 0.8/3.7        | 0.7/3.8          | μА    | Min/Max |
| Sync tip clamp bias curr | ent   | Bias = ac STC, mid bias               | 5.9       | 4.2/8     | 4/8.2          | 3.9/8.3          | μA    | Min/Max |
|                          |   | Bias = ac STC, high bias              | 8.2       | 6.1/10.8  | 6/1            | 5.9/11.1         | μА    | Min/Max |
|                          |   | . 5                                   |           | 1         |                |                  | r     |         |
| INPUT CHARACTERIS        | TICS  |                                       |           |           |                |                  |       |         |

(2) Bandwidth up to 100-MHz, No Weighting, Tilt Null



## ELECTRICAL CHARACTERISTICS, $V_A = V_{DD} = 3.3 \text{ V}$ (continued)

 $R_L$  = 150  $\Omega$  || 5 pF to GND for Monitor Output, 19 k $\Omega$  || 8 pF Load to GND for ADC Buffer, ADC Buffer Filter = 9 MHz, SAG pin shorted to Monitor Output Pin (unless otherwise noted)

|   |                       |   | TYP      |          | ov             | ER TEMPERAT      | URE   |         |
|---|-----------------------|---|----------|----------|----------------|------------------|-------|---------|
| PARAMETER                                 |                       | TEST CONDITIONS   | 25°C     | 25°C     | 0°C to<br>70°C | –40°C to<br>85°C | UNITS | MIN/MAX |
| Input resistance                          |                       | Bias = ac bias mode   | 25       |          |                |                  | kΩ    | Тур     |
| put rooiotanoo                            |                       | Bias = dc, dc + Shift, ac STC   | 3        |          |                |                  | MΩ    | Тур     |
| Input capacitance                         |                       |   | 1.5      |          |                |                  | pF    | Тур     |
| OUTPUT CHARACTER                          | ISTICS - MONITOR      | ОИТРИТ  |          |          |                |                  |       |         |
|   |                       | $R_L = 150 \Omega$ to Midrail   | 3.15     | 2.9      | 2.8            | 2.8              | V     | Min     |
| High output voltage swir                  |                       | $R_L$ = 150 $\Omega$ to GND   | 3.05     | 2.85     | 2.75           | 2.75             | V     | Min     |
| migri output voitage swii                 | ig                    | $R_L = 75 \Omega$ to Midrail  | 3.05     |          |                |                  | V     | Min     |
|   |                       | $R_L$ = 75 $\Omega$ to GND  | 2.9      |          |                |                  | V     | Min     |
|   |                       | $R_L = 150 \Omega$ to Midrail   | 0.15     | 0.25     | 0.28           | 0.29             | V     | Min     |
|   |                       | $R_L$ = 150 $\Omega$ to GND   | 0.1      | 0.18     | 0.21           | 0.22             | V     | Min     |
| Low output voltage swin                   | g                     | $R_L = 75 \Omega$ to Midrail  | 0.25     |          |                |                  | V     | Min     |
|   |                       | $R_L = 75 \Omega$ to GND  | 0.08     |          |                |                  | V     | Min     |
| _   | Sourcing              | $R_L = 10 \Omega$ to Midrail  | 80       | 50       | 47             | 45               | mA    | Min     |
| Output current                            | Sinking               | $R_L = 10 \Omega$ to Midrail  | 75       | 50       | 47             | 45               | mA    | Min     |
| OUTPUT CHARACTER                          | ISTICS - BUFFER C     | UTPUT   |          |          |                |                  |       |         |
| High Output Voltage Sw range and G = 0dB) | ing (Limited by input |   | 2        | 1.8      | 1.75           | 1.75             | V     | Min     |
| Low Output Voltage Swi range and G = 0dB) | ng (Limited by input  | - Load = 19kΩ  8pF to Midrail   | 0.14     | 0.24     | 0.27           | 0.28             | V     | Max     |
|   | Sourcing              | RL = 10 Ω to GND  | 80       | 50       | 47             | 45               | mA    | Min     |
| Output Current                            | Sinking               | RL = 10 Ω to Midrail  | 75       | 50       | 47             | 45               | mA    | Min     |
| POWER SUPPLY – AN                         | ALOG                  |   |          |          |                |                  |       |         |
| Maximum operating volta                   |                       | VA  | 3.3      | 5.5      | 5.5            | 5.5              | V     | Max     |
| Minimum operating volta                   |                       | VA  | 3.3      | 2.7      | 2.7            | 2.7              | V     | Min     |
| Maximum quiescent curi                    |                       | VA, DC+Shift Mode, Vin = 100 mV   | 100      | 120      | 123            | 125              | mA    | Max     |
| Minimum quiescent current                 |                       | VA, DC+Shift Mode, Vin = 100 mV   | 100      | 80       | 77             | 75               | mA    | Min     |
| Power supply rejection (                  |                       | Buffer Output   | 50       | - 00     |                | 70               | dB    | Тур     |
| POWER SUPPLY - DIG                        |                       | Daller Galpat   | 00       |          |                |                  | ub.   | 1,712   |
| Maximum operating volt                    |                       | VDD   | 3.3      | 5.5      | 5.5            | 5.5              | V     | Max     |
|   |                       | VDD   | 3.3      | 2.7      | 2.7            | 2.7              | V     | Min     |
| Minimum operating volta                   |                       | VDD, Vin = 0 V  | 0.65     | 1.2      |                |                  |       | Max     |
| Maximum quiescent curi                    |                       |   |          |          | 1.3            | 1.4              | mA    |         |
| Minimum quiescent curr                    |                       | VDD, Vin = 0 V  | 0.65     | 0.35     | 0.3            | 0.25             | mA    | Min     |
| DISABLE CHARACTER                         | (1511C5 - ALL CHAI    |   |          | 1        |                |                  |       | T -     |
| Quiescent current                         |                       | All 3 channels disabled (3)   | 0.1      |          |                |                  | μΑ    | Тур     |
| Turn-on time delay (t <sub>ON</sub> )     |                       | Time for Is to reach 50% of final value after I <sup>2</sup> C                  | 5        |          |                |                  | μs    | Тур     |
| Turn-on time delay (t <sub>OFF</sub> )    |                       | control is initiated  | 2        |          |                |                  | μs    | Тур     |
| HV SYNC CHARACTER                         |                       |   |          |          |                |                  |       |         |
| Schmitt Trigger Adj. Pin                  |                       | Reference for Schmitt Trigger   | 1.48     | 1.35/1.6 | 1.3/1.65       | 1.27/1.68        | V     | Min/Max |
| Schmitt Trigger Thresho                   | ld Range              | Allowable range for Sch. Trig. Adj.   | 0.9 to 2 |          |                |                  | V     | Тур     |
| Schmitt Trigger VT+                       |                       | Positive Going Input Voltage Threshold Relative to<br>Schmitt Trigger Threshold | 0.25     |          |                |                  | V     | Тур     |
| Schmitt Trigger VT-                       |                       | Negative Going Input Voltage Threshold Relative to Schmitt Trigger Threshold    | -0.3     |          |                |                  | V     | Тур     |
| Schmitt Trigger Thresho<br>Resistance     | ld Pin Input          | Input Resistance into Control Pin   | 10       |          |                |                  | kΩ    | Тур     |
| H V Sync Input Impedance                  |                       |   | 10       |          |                |                  | ΜΩ    | Тур     |
| H V Sync High Output Voltage              |                       | 1kΩ to GND  | 3.15     | 3.05     | 3              | 3                | V     | Min     |
| H V Sync Low Output Vo                    | oltage                | 1kΩ to GND  | 0.01     | 0.05     | 0.1            | 0.1              | V     | Max     |
| H V Sync Source Currer                    | nt                    | 10Ω to GND  | 50       | 35       | 30             | 30               | mA    | Min     |
| H V Sync Sink Current                     |                       | 10Ω to VDD  | 35       | 25       | 23             | 21               | mA    | Min     |
| H V Delay                                 |                       | Delay from Input to Output  | 6.5      |          |                |                  | ns    | Тур     |
| H V to Buffer Output Ske                  |                       | No Filter on Buffer Channel   | 5        | 1        |                |                  | ns    | Тур     |

<sup>(3)</sup> Note that the I<sup>2</sup>C circuitry is still active while in Disable mode. The current shown is while there is no activity with the THS7327's circuitry.



## ELECTRICAL CHARACTERISTICS, $V_A = V_{DD} = 5 \text{ V}$

 $R_L$  = 150 $\Omega$  || 5pF to GND for Monitor Output, 19k $\Omega$  || 8pF Load to GND for ADC Buffer, ADC Buffer Filter = 9MHz, SAG pin shorted to Monitor Output Pin (unless otherwise noted)

|   | TED   | TEGT COMPLETIONS   | TYP                   |          | 1              | ER TEMPERAT      | URE   |         |
|---|---|--|-----------------------|----------|----------------|------------------|-------|---------|
| PARAME  | TER   | TEST CONDITIONS  | 25°C                  | 25°C     | 0°C to<br>70°C | –40°C to<br>85°C | UNITS | MIN/MAX |
| AC PERFORMANCE                                |   |  |                       |          |                |                  |       |         |
|   |   | Filter Select = 9 MHz <sup>(1)</sup>                       | 9                     | 6.8/10.4 | 6.7/10.5       | 6.7/10.5         | MHz   | Min/Max |
|   |   | Filter Select = 16 MHz <sup>(1)</sup>                      | 16                    | 13.1/9.6 | 12.9/19.7      | 12.8/19.7        | MHz   | Min/Max |
| Small-signal bandwidth                        | Buffer Output<br>$V_O = 0.2 V_{PP}$                 | Filter Select = 35 MHz <sup>(1)</sup>                      | 35                    | 28/40.5  | 27.8/41.3      | 27.7/41.3        | MHz   | Min/Max |
| (–3 dB)                                       | 0 - 11  | Filter Select = 75 MHz <sup>(1)</sup>                      | 78                    | 64/89    | 63.5/92.3      | 63.4/92.4        | MHz   | Min/Max |
|   |   | Filter Select = Bypass                                     | 500                   |          |                |                  | MHz   | Тур     |
|   | MonitorOutput                                       |  | 500                   |          |                |                  | MHz   | Тур     |
|   |   | Filter Select = 9 MHz                                      | 9                     |          |                |                  | MHz   | Тур     |
|   |   | Filter Select = 16 MHz                                     | 16                    |          |                |                  | MHz   | Тур     |
| Large-signal bandwidth                        | Buffer Output<br>V <sub>O</sub> = 1 V <sub>PP</sub> | Filter Select = 35 MHz                                     | 35                    |          |                |                  | MHz   | Тур     |
| (-3 dB)                                       | 40 - 1 Abb  | Filter Select = 75 MHz                                     | 78                    |          |                |                  | MHz   | Тур     |
|   |   | Filter Select = Bypass                                     | 500                   |          |                |                  | MHz   | Тур     |
|   | Monitor Output                                      | V <sub>O</sub> = 2 V <sub>PP</sub>                         | 425                   |          |                |                  | MHz   | Тур     |
|   | Buffer Output                                       | Filter Select = Bypass: V <sub>O</sub> = 1 V <sub>PP</sub> | 1150                  |          |                |                  | V/µs  | Тур     |
| Slew rate                                     | Monitor Output                                      | $V_0 = 2 V_{PP}$   | 1300                  |          |                |                  | V/μs  | Тур     |
|   | -   | Filter Select = 9 MHz                                      | 56                    |          |                |                  | ns    | Тур     |
|   |   | Filter Select = 16 MHz                                     | 31                    |          |                |                  | ns    | Тур     |
|   | Buffer Output                                       | Filter Select = 35 MHz                                     | 16                    |          |                |                  | ns    | Тур     |
| Group delay at 100 kHz                        |   | Filter Select = 75 MHz                                     | 8                     |          |                |                  | ns    | Тур     |
|   |   | Filter Select = Bypass                                     | 1.3                   |          |                |                  | ns    | Тур     |
|   | Monitor Output                                      |  | 1.25                  |          |                |                  | ns    | Тур     |
|   |   | Filter Select = 9 MHz; at 5.1 MHz                          | 10.5                  |          |                |                  | ns    | Тур     |
| Crown delevinerietien                         |   | Filter Select = 16 MHz: at 11 MHz                          | 7.2                   |          |                |                  | ns    | Тур     |
| Group delay variation with respect to 100 kHz | Buffer Output                                       | Filter Select = 35 MHz: at 27 MHz                          | 4                     |          |                |                  | ns    | Тур     |
|   |   | Filter Select = 75 MHz: at 54 MHz                          | 2                     |          |                |                  | ns    | Тур     |
|   |   | Filter Select = 9 MHz: at 5.75 MHz                         | 0.4                   | -0.3/1.5 | -0.35/1.55     | -0.4/1.6         | dB    | Min/Max |
|   | Buffer Output (2)                                   | Filter Select = 9 MHz: at 27 MHz                           | 39                    | 31       | 30.5           | 30               | dB    | Min     |
|   |   | Filter Select = 16 MHz: at 11 MHz                          | 0.5                   | -0.3/1.5 | -0.35/1.55     | -0.4/1.6         | dB    | Min/Max |
|   |   | Filter Select = 16 MHz: at 54 MHz                          | 40                    | 32       | 31.5           | 31               | dB    | Min     |
| Attenuation with respect to 100 kHz           |   | Filter Select = 35 MHz: at 27 MHz                          | 1                     | -0.3/2.7 | -0.35/2.75     | -0.4/2.8         | dB    | Min/Max |
| ·   |   | Filter Select = 35 MHz: at 27 MHz                          | 27                    | 19       | 18.5           | 18               | dB    | Min     |
|   |   | Filter Select = 75 MHz: at 74 MHz                          | 0.6                   | -0.3/1.8 | -0.4/1.9       | -0.45/2          | dB    | Min/Max |
|   |   | Filter Select = 75 MHz: at 34 MHz                          | 25                    | 17       | 16.5           | 16               | dB    | Min     |
|   | Duffer Output                                       |  |                       | 17       | 16.5           | 10               | %     |         |
| Differential gain                             | Buffer Output                                       | Filter Select = 9 MHz: NTSC/PAL  NTSC/PAL                  | 0.3/0.45<br>0.07/0.08 |          |                |                  |       | Тур     |
|   | Monitor Output                                      |  |                       |          |                |                  | %     | Тур     |
| Differential phase                            | Buffer Output                                       | Filter Select = 9 MHz: NTSC/PAL                            | 0.45/0.5              |          |                |                  |       | Тур     |
|   | Monitor Output                                      | NTSC/PAL   | 0.07/0.08             |          |                |                  |       | Тур     |
|   |   | Filter Select = 9 MHz                                      | -61                   |          |                |                  | dB    | Тур     |
| Total harmonic                                | Buffer Output                                       | Filter Select = 16 MHz                                     | -60                   |          |                |                  | dB    | Тур     |
| distortion                                    | $V_O = 1 V_{PP}$                                    | Filter Select = 35 MHz                                     | -57                   |          |                |                  | dB    | Тур     |
| f = 1 MHz                                     |   | Filter Select = 75 MHz                                     | -55                   |          |                |                  | dB    | Тур     |
|   |   | Filter Select = Bypass                                     | -60                   | 1        |                |                  | dB    | Тур     |
|   | Monitor Output                                      | $V_0 = 2 V_{PP}$   | -60                   |          |                |                  | dB    | Тур     |
|   |   | Filter Select = 9 MHz                                      | 80                    |          |                |                  | dB    | Тур     |
|   |   | Filter Select = 16 MHz                                     | 77                    |          |                |                  | dB    | Тур     |
| Signal to noise ratio                         | Buffer Output                                       | Filter Select = 35 MHz                                     | 75                    |          |                |                  | dB    | Тур     |
| (unified weighting)                           |   | Filter Select = 75 MHz                                     | 73                    |          |                |                  | dB    | Тур     |
|   |   | Filter Select = Bypass <sup>(3)</sup>                      | 66                    |          |                |                  | dB    | Тур     |
|   | Monitor Output                                      | See (3)  | 71                    |          |                |                  | dB    | Тур     |

- The Min/Max values listed are specified by design only. Performance guaranteed by design, characterization, and 3.3V testing only. Bandwidth up to 100-MHz, No Weighting, Tilt Null (2) (3)



## ELECTRICAL CHARACTERISTICS, $V_A = V_{DD} = 5 \text{ V}$ (continued)

 $R_L$  = 150 $\Omega$  || 5pF to GND for Monitor Output, 19k $\Omega$  || 8pF Load to GND for ADC Buffer, ADC Buffer Filter = 9MHz, SAG pin shorted to Monitor Output Pin (unless otherwise noted)

| DADAMETED                    |                  |                                       | TYP   | OVER TEMPERATURE |                |                  |       |                |  |
|------------------------------|------------------|---------------------------------------|-------|------------------|----------------|------------------|-------|----------------|--|
| PARAME                       | ETER             | TEST CONDITIONS                       | 25°C  | 25°C             | 0°C to<br>70°C | –40°C to<br>85°C | UNITS | MIN/MA         |  |
|                              |                  | Filter Select = 9 MHz: at 5 MHz       | -58   |                  |                |                  | dB    | Тур            |  |
|                              |                  | Filter Select = 16 MHz: at 10 MHz     | -65   |                  |                |                  | dB    | Тур            |  |
| Channel-to-Channel           | Buffer Output    | Filter Select = 35 MHz: at 27 MHz     | -58   |                  |                |                  | dB    | Тур            |  |
| Crosstalk                    |                  | Filter Select = 75 MHz: at 60 MHz     | -58   |                  |                |                  | dB    | Тур            |  |
|                              |                  | Filter Select = Bypass: at 100 MHz    | -47   |                  |                |                  | dB    | Тур            |  |
|                              | Monitor Output   | F = 100 MHz                           | -35   |                  |                |                  | dB    | Тур            |  |
|                              |                  | Filter Select = 9 MHz: at 5.5 MHz     | 65    |                  |                |                  | dB    | Тур            |  |
|                              |                  | Filter Select = 16 MHz: at 11 MHz     | 65    |                  |                |                  | dB    | Тур            |  |
| MUX Isolation                | Buffer Output    | Filter Select = 35 MHz: at 27 MHz     | 65    |                  |                |                  | dB    | Тур            |  |
|                              |                  | Filter Select = Bypass: at 60 MHz     | 65    |                  |                |                  | dB    | Тур            |  |
|                              | Monitor Output   | f = 100 MHz                           | 66    |                  |                |                  | dB    | Тур            |  |
|                              | Buffer Output    | f = 100 kHz; V <sub>O</sub> = 1Vpp    | 0     |                  |                |                  | dB    | Тур            |  |
| Gain                         | Monitor Output   | f = 100 kHz; V <sub>0</sub> = 2Vpp    | 6     | 5.8/6.25         | 5.75/6.3       | 5.75/6.35        | dB    | Min/Max        |  |
|                              | Buffer Output    | 1 – 100 κπ2, νδ – 2νρρ                | 6     | 3.0/0.23         | 3.73/0.3       | 3.73/0.33        | ns    | Тур            |  |
| Settling time                |                  | Vin = 1 Vpp; 0.5% Settling            |       |                  |                |                  |       |                |  |
|                              | Monitor Output   | ( 40.40)                              | 6     |                  |                |                  | ns    | Тур            |  |
| Output impedance             | Buffer Output    | f = 10 MHz                            | 2     |                  |                |                  | Ω     | Тур            |  |
|                              | Monitor Output   | f = 10 MHz                            | 0.4   |                  |                |                  | Ω     | Тур            |  |
| DC PERFORMANCE               |                  |                                       | T     |                  |                |                  |       | _              |  |
| Output offset voltage        | Buffer Output    | Bias = dc, Filter = 16 MHz            | 50    | 120              | 125            | 125              | mV    | Max            |  |
|                              | Monitor Output   | Bias = dc                             | 5     | 80               | 85             | 85               | mV    | Max            |  |
| Average offset voltage drift | Buffer Output    | Bias = dc                             |       |                  |                | 20               | μV/°C | Тур            |  |
|                              | Monitor Output   | Bias = dc                             |       |                  |                | 20               | μV/°C | Тур            |  |
| Diagonal and the second      | Duffer Output    | Bias = dc + Shift, Vin = 0 V          | 345   | 265/425          | 255/430        | 250/435          | mV    | Min/Max        |  |
|                              | Buffer Output    | Bias = ac                             | 1.55  | 1.4/1.7          | 1.35/1.75      | 1.35/1.75        | V     | Min/Max        |  |
| Bias output voltage          |                  | Bias = dc + Shift, Vin = 0 V          | 230   | 150/320          | 145/325        | 140/330          | mV    | Min/Max        |  |
|                              | Monitor Output   | Bias = ac                             | 2.65  | 2.5/2.8          | 2.45/2.85      | 2.45/2.85        | V     | Min/Max        |  |
| Sync tip clamp output        | Buffer Output    |                                       | 350   | 265/430          | 260/435        | 255/440          | mV    | Min/Max        |  |
| voltage                      | Monitor Output   | Bias = ac STC, clamp voltage          | 305   | 210/400          | 205/405        | 200/410          | mV    | Min/Max        |  |
| Input bias current           | ,                | Bias = dc – implies lb out of the pin | -1.4  | -3               | -3.5           | -3.5             | μА    | Max            |  |
| Average bias current drift   | ft               | Bias = dc                             |       |                  |                | 10               | nA/°C | Тур            |  |
|                              |                  | Bias = ac STC, low bias               | 2.45  | 1/3.9            | 0.9/4          | 0.8/4.1          | μА    | Min/Max        |  |
| Sync tip clamp bias curre    | ent              | Bias = ac STC, mid bias               | 6.35  | 4.3/8.4          | 4.1/8.6        | 4/8.7            | μА    | Min/Max        |  |
| Cyric up clamp bias cum      | SIIL             | Bias = ac STC, high bias              | 8.75  | 6.4/11.2         | 6.2/11.4       | 6.1/11.5         | μΑ    | Min/Max        |  |
| INPUT CHARACTERIS            | rice             | bias – ac 310, riigii bias            | 0.73  | 0.4/11.2         | 0.2/11.4       | 0.1/11.5         | μΛ    | IVIII I/ IVIAX |  |
|                              | 1103             | Diag. da                              | 0/0.5 | 0/0.45           | 0/0.4          | 0/0.4            |       | T              |  |
| Input voltage range          |                  | Bias = dc                             | 0/2.5 | 0/2.45           | 0/2.4          | 0/2.4            | V     | Тур            |  |
| Input resistance             |                  | Bias = ac bias mode                   | 20    |                  |                |                  | kΩ    | Тур            |  |
|                              |                  | Bias = dc, dc + Shift, ac STC         | 3     |                  |                |                  | MΩ    | Тур            |  |
| Input capacitance            |                  |                                       | 2     |                  |                |                  | pF    | Тур            |  |
| OUTPUT CHARACTER             | ISTICS – MONITOR |                                       |       |                  | 1              |                  | Т     | _              |  |
|                              |                  | $R_L = 150 \Omega$ to Midrail         | 4.8   | 4.65             | 4.6            | 4.6              | V     | Min            |  |
| High output voltage swin     | ıa               | $R_L = 150 \Omega$ to GND             | 4.7   | 4.55             | 4.5            | 4.5              | V     | Min            |  |
| J. Tarpar Tonago OWIII       | 9                | $R_L = 75 \Omega$ to Midrail          | 4.7   |                  |                |                  | V     | Min            |  |
|                              |                  | $R_L = 75 \Omega$ to GND              | 4.6   |                  |                |                  | V     | Min            |  |
|                              |                  | $R_L = 150 \Omega$ to Midrail         | 0.19  | 0.25             | 0.28           | 0.3              | V     | Min            |  |
| Laurantant V                 | _                | $R_L = 150 \Omega$ to GND             | 0.11  | 0.19             | 0.23           | 0.24             | V     | Min            |  |
| Low output voltage swin      | y                | $R_L = 75 \Omega$ to Midrail          | 0.24  |                  |                |                  | V     | Min            |  |
|                              |                  | $R_L = 75 \Omega$ to GND              | 0.085 |                  |                |                  | V     | Min            |  |
|                              | Sourcing         | $R_L = 10 \Omega$ to Midrail          | 110   | 85               | 80             | 75               | mA    | Min            |  |
| Output current               | Sinking          | $R_L = 10 \Omega$ to Midrail          | 115   | 85               | 80             | 75               | mA    | Min            |  |



## ELECTRICAL CHARACTERISTICS, $V_A = V_{DD} = 5 \text{ V}$ (continued)

 $R_L$  = 150 $\Omega$  || 5pF to GND for Monitor Output, 19k $\Omega$  || 8pF Load to GND for ADC Buffer, ADC Buffer Filter = 9MHz, SAG pin shorted to Monitor Output Pin (unless otherwise noted)

|  |                        |   | TYP      | OVER TEMPERATURE |                |                  |       |         |  |
|--|------------------------|---|----------|------------------|----------------|------------------|-------|---------|--|
| PARAMI                                       | ETER                   | TEST CONDITIONS   | 25°C     | 25°C             | 0°C to<br>70°C | –40°C to<br>85°C | UNITS | MIN/MAX |  |
| OUTPUT CHARACTER                             | ISTICS – BUFFER O      | UTPUT   |          |                  |                |                  |       |         |  |
| High Output Voltage Sw range and G = 0dB)    | ving (Limited by input | Lood 40k0ll0nF to Midrail   | 3.4      | 3.1              | 3              | 3                | V     | Min     |  |
| Low Output Voltage Swi<br>range and G = 0dB) | ing (Limited by input  | - Load = 19kΩ  8pF to Midrail   | 0.14     | 0.24             | 0.27           | 0.28             | V     | Max     |  |
| 0.44 04                                      | Sourcing               | RL = 10 $\Omega$ to GND   | 110      | 85               | 80             | 75               | mA    | Min     |  |
| Output Current                               | Sinking                | RL = 10 $\Omega$ to Midrail   | 80       | 85               | 80             | 75               | mA    | Min     |  |
| POWER SUPPLY - AN                            | ALOG                   | ,   | -11      | 1                |                |                  |       |         |  |
| Maximum operating volt                       | tage                   | VA  | 5        | 5.5              | 5.5            | 5.5              | V     | Max     |  |
| Minimum operating volta                      | age                    | VA  | 5        | 2.7              | 2.7            | 2.7              | V     | Min     |  |
| Maximum quiescent cur                        | rent                   | VA, DC+Shift Mode, Vin = 100 mV   | 118      | 145              | 148            | 150              | mA    | Max     |  |
| Minimum quiescent curr                       | ent                    | VA, DC+Shift Mode, Vin = 100 mV   | 118      | 95               | 92             | 90               | mA    | Min     |  |
| Power supply rejection (                     | (+PSRR)                | Buffer Output   | 46       |                  |                |                  | dB    | Тур     |  |
| POWER SUPPLY - DIG                           | GITAL                  |   |          |                  |                | I .              |       |         |  |
| Maximum operating voltage                    |                        | VDD   | 5        | 5.5              | 5.5            | 5.5              | V     | Max     |  |
| Minimum operating voltage                    |                        | VDD   | 5        | 2.7              | 2.7            | 2.7              | V     | Min     |  |
| Maximum quiescent current                    |                        | VDD, Vin = 0 V  | 1        | 2                | 3              | 3                | mA    | Max     |  |
| Minimum quiescent current                    |                        | VDD, Vin = 0 V  | 1        | 0.5              | 0.4            | 0.4              | mA    | Min     |  |
| DISABLE CHARACTER                            | RISTICS – ALL CHAN     | NNELS DISABLED  |          |                  |                | I .              |       |         |  |
| Quiescent current                            |                        | All channels disabled (4)   | 1        |                  |                |                  | μΑ    | Тур     |  |
| Turn-on time delay (t <sub>ON</sub> )        |                        | Time for Is to reach 50% of final value after I <sup>2</sup> C control is initiated | 5        |                  |                |                  | μs    | Тур     |  |
| Turn-on time delay (t <sub>OFF</sub>         | r)                     |   | 2        |                  |                |                  | μs    | Тур     |  |
| HV SYNC CHARACTER                            | RISTICS(5)             |   |          |                  |                |                  |       |         |  |
| Schmitt Trigger Adj. Pin                     | Voltage                | Reference for Schmitt Trigger   | 1.55     | 1.45/1.65        | 1.4/1.7        | 1.37/1.73        | V     | Min/Max |  |
| Schmitt Trigger Thresho                      | old Range              | Allowable range for Sch. Trig. Adj.   | 0.9 to 2 |                  |                |                  | V     | Тур     |  |
| Schmitt Trigger VT+                          |                        | Positive Going Input Voltage Threshold Relative to Schmitt Trigger Threshold        | 0.25     |                  |                |                  | V     | Тур     |  |
| Schmitt Trigger VT-                          |                        | Negative Going Input Voltage Threshold Relative to Schmitt Trigger Threshold        | -0.3     |                  |                |                  | V     | Тур     |  |
| Schmitt Trigger Thresho<br>Resistance        | old Pin Input          | Input Resistance into Control Pin   | 10       |                  |                |                  | kΩ    | Тур     |  |
| H V Sync Input Impedance                     |                        |   | 10       |                  |                |                  | MΩ    | Тур     |  |
| H V Sync High Output Voltage                 |                        | 1kΩ to GND  | 4.8      | 4.7              | 4.6            | 4.6              | V     | Min     |  |
| H V Sync Low Output Voltage                  |                        | 1kΩ to GND  | 0.01     | 0.05             | 0.1            | 0.1              | V     | Max     |  |
| H V Sync Source Current                      |                        | 10Ω to GND  | 90       | 60               | 55             | 55               | mA    | Min     |  |
| H V Sync Sink Current                        |                        | 10Ω to VDD  | 50       | 30               | 27             | 25               | mA    | Min     |  |
| H V Delay                                    |                        | Delay from Input to Output  | 6.5      |                  |                |                  | ns    | Тур     |  |
| H V to Buffer Output Sk                      | ew                     | No Filter on Buffer Channel   | 5        |                  |                |                  | ns    | Тур     |  |

<sup>(4)</sup> Note that the I<sup>2</sup>C circuitry is still active while in Disable mode. The current shown is while there is no activity with the THS7327's I<sup>2</sup>C circuitry.

<sup>(5)</sup> Schmitt Trigger threshold is defined by (VT+ – VT–)/2.



## TIMING REQUIREMENTS FOR I<sup>2</sup>C INTERFACE<sup>(1)</sup>

 $V_{DD} = 2.7 \text{ V to 5 V}$ 

|                    | PARAMETER                                       | STANDARD | MODE | FAST M | ODE | UNIT |
|--------------------|---|----------|------|--------|-----|------|
|                    | FARAINETER                                      | MIN      | MAX  | MIN    | MAX | UNII |
| f <sub>SCL</sub>   | Clock frequency, SCL                            | 0        | 100  | 0      | 400 | kHz  |
| t <sub>w(H)</sub>  | Pulse duration, SCL high                        | 4        |      | 0.6    |     | μs   |
| t <sub>w(L)</sub>  | Pulse duration, SCL low                         | 4.7      |      | 1.3    |     | μs   |
| t <sub>r</sub>     | Rise time, SCL and SDA                          |          | 1000 |        | 300 | ns   |
| t <sub>f</sub>     | Fall time, SCL and SDA                          |          | 300  |        | 300 | ns   |
| t <sub>su(1)</sub> | Setup time, SDA to SCL                          | 250      |      | 100    |     | ns   |
| t <sub>h(1)</sub>  | Hold time, SCL to SDA                           | 0        |      | 0      |     | ns   |
| t <sub>(buf)</sub> | Bus free time between stop and start conditions | 4.7      |      | 1.3    |     | μs   |
| t <sub>su(2)</sub> | Setup time, SCL to start condition              | 4.7      |      | 0.6    |     | μs   |
| t <sub>h(2)</sub>  | Hold time, start condition to SCL               | 4        |      | 0.6    |     | μs   |
| t <sub>su(3)</sub> | Setup time, SCL to stop condition               | 4        |      | 0.6    |     | μs   |
| C <sub>b</sub>     | Capacitive load for each bus line               |          | 400  |        | 400 | pF   |

(1) The THS7327  $I^2C$  address = 01011A2A1A0. See the application information section for more information.

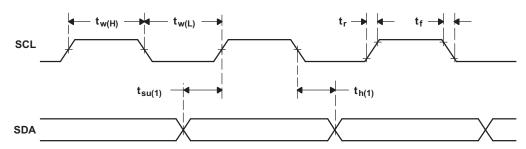


Figure 2. SCL and SDA Timing

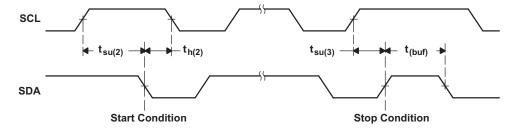
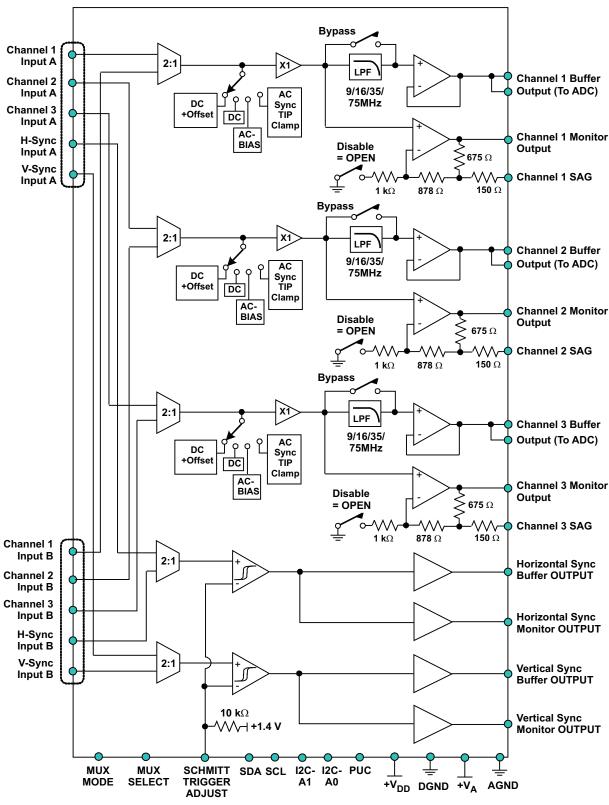


Figure 3. Start and Stop Conditions



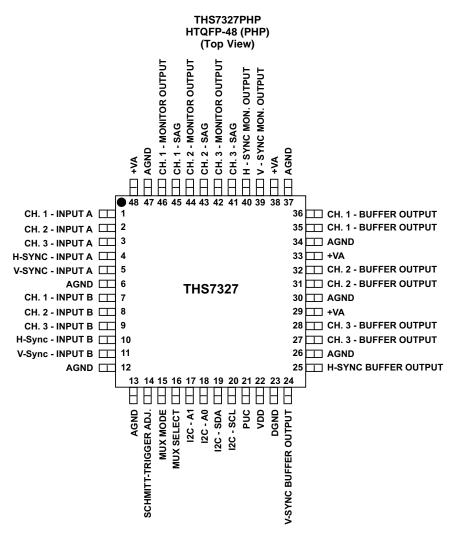
#### **FUNCTIONAL DIAGRAM**



NOTE: The I<sup>2</sup>C Address of the THS7327 is 01011(A1)(A0)(R/ $\overline{W}$ )



#### **PIN CONFIGURATION**



#### **TERMINAL FUNCTIONS**

| TERMINAL            | _               |     |  |  |  |  |
|---------------------|-----------------|-----|--|--|--|--|
| NAME                | NO.<br>HTQFP-48 | I/O | DESCRIPTION  |  |  |  |
| CH. 1 – INPUT A     | 1               | I   | Video Input Channel 1 – Input A  |  |  |  |
| CH. 2 – INPUT A     | 2               | I   | Video Input Channel 2 – Input A  |  |  |  |
| CH. 3 – INPUT A     | 3               | I   | Video Input Channel 3 – Input A  |  |  |  |
| H-Sync – INPUT A    | 4               | I   | Horizontal Sync – Input A  |  |  |  |
| V-Sync – INPUT A    | 5               | I   | Vertical Sync – Input A  |  |  |  |
| CH. 1 – INPUT B     | 7               | I   | Video Input Channel 1 – Input B  |  |  |  |
| CH. 2 – INPUT B     | 8               | I   | Video Input Channel 2 – Input B  |  |  |  |
| CH. 3 – INPUT B     | 9               | I   | Video Input Channel 3 – Input B  |  |  |  |
| H-Sync – INPUT B    | 10              | I   | Horizontal Sync – Input B  |  |  |  |
| V-Sync – INPUT B    | 11              | I   | Vertical Sync – Input B  |  |  |  |
| I <sup>2</sup> C-A1 | 17              | I   | I <sup>2</sup> C Slave Address Control Bit A1 – Connect to Vs+ for a Logic 1 preset value or GND for a Logic 0 preset value. |  |  |  |
| I <sup>2</sup> C-A0 | 18              | I   | I <sup>2</sup> C Slave Address Control Bit A0 – Connect to Vs+ for a Logic 1 preset value or GND for a Logic 0 preset value. |  |  |  |



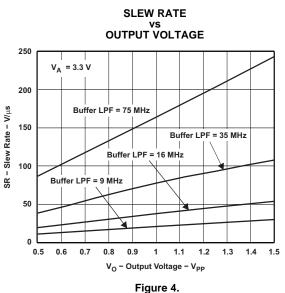
## **TERMINAL FUNCTIONS (continued)**

| TERMINAL                          | -                               |     |  |
|-----------------------------------|---------------------------------|-----|--|
| NAME                              | NO.<br>HTQFP-48                 | I/O | DESCRIPTION  |
| SDA                               | 19                              | I/O | Serial data line of the I2C bus. Pull-up resistor should have a minimum value = $2-k\Omega$ and a maximum value = $19-k\Omega$ . Pull up to Vs+  |
| SCL                               | 20                              | I   | I <sup>2</sup> C bus Clock Line. Pull-up resistor should have a minimum value = $2$ -k $\Omega$ and a maximum value = $19$ -k $\Omega$ . Pull up to Vs+  |
| PUC                               | 21                              | I   | Power-Up Condition – Connect to GND for all channels disabled upon power-up. Connect to VDD (Logic High) to set Buffer Outputs to OFF and Monitor Outputs ON with AC-Bias configuration on Channels 1 to 3 and HV syncs are enabled. |
| MUX MODE                          | 15                              | I   | Sets the MUX configuration control – Connect to GND for MUX Select Pin Control. Connect to Logic High for I2C control of the MUX.  |
| MUX Select                        | 16                              | -   | Controls the MUX selection when MODE Pin is set to Logic High. Connect to GND for MUX selector set to Input A. Connect to Logic High for MUX selector set to Input B.  |
| CH. 1 –Buffer Output              | 35, 36                          | 0   | Output Channel 1 from Either CH. 1 – INPUT A or CH. 1 – INPUT B – Connect to ADC / Scalar / Decoder  |
| CH. 2 –Buffer Output              | 31, 32                          | 0   | Output Channel 1 from Either CH. 2 – INPUT A or CH. 2 – INPUT B – Connect to ADC / Scalar / Decoder  |
| CH. 3 –Buffer Output              | 27, 28                          | 0   | Output Channel 3 from Either CH. 3 – INPUT A or CH. 3 – INPUT B – Connect to ADC / Scalar / Decoder  |
| Horizontal Sync Output            | 25                              | 0   | Horizontal Sync Output – Connect to ADC / Scalar H-sync Input  |
| Vertical Sync Output              | 24                              | 0   | Vertical Sync Output – Connect to ADC / Scalar V-sync Input  |
| CH. 1 - SAG                       | 45                              | 0   | Video Monitor Pass-Thru Output Channel 1 SAG Correction Pin. If SAG is not used, Connect Directly to CH. 1 – OUTPUT Pin 46.  |
| CH. 1 – OUTPUT                    | 46                              | 0   | Video Monitor Pass-Thru Output Channel 1 From Either CH. 1 – INPUT A or CH. 1 – INPUT B  |
| CH. 2 - SAG                       | 43                              | 0   | Video Monitor Pass-Thru Output Channel 2 SAG Correction Pin. If SAG is not Used, Connect Directly to CH. 2 – OUTPUT Pin 44.  |
| CH. 2 – OUTPUT                    | 44                              | 0   | Video Monitor Pass-Thru Output Channel 2 From Either CH. 2 – INPUT A or CH. 2 – INPUT B  |
| CH. 3 - SAG                       | 41                              | 0   | Video Monitor Pass-Thru Output Channel 3 SAG Correction Pin. If SAG is not Used, Connect Directly to CH. 3 – OUTPUT Pin 42.  |
| CH. 3 – OUTPUT                    | 42                              | 0   | Video Monitor Pass-Thru Output Channel 3 From Either CH. 3 – INPUT A or CH. 3 – INPUT B  |
| Horizontal Sync<br>Monitor Output | 40                              | 0   | Horizontal Sync Monitor Pass-Thru Output   |
| Vertical Sync Monitor<br>Output   | 39                              | 0   | Vertical Sync Monitor Pass-Thru Output   |
| AGND                              | 6, 12, 13,<br>26, 30, 34,<br>37 | I   | Ground Reference Pin for Analog Signals. Internally these pins connect to DGND. Although it is recommended to have the AGND and DGND connected to the proper signals for best results.   |
| +VA                               | 29, 33, 38,<br>37               | I   | Analog Positive Power Supply Input Pins – connect to 2.7 V to 5 V. Must be equal to or greater than VDD.   |
| VDD                               | 23                              | I   | Digital Positive Supply Pin for I <sup>2</sup> C circuitry and HV Sync Outputs – Connect to 2.7 V to 5 V.  |
| DGND                              | 22                              | I   | Digital GND pin for HV Circuitry and I2C circuitry.  |
| Schmitt Trigger Adjust            | 14                              | I   | Defaults to 1.45V (TTL compatible). Connect to external voltage reference to adjust HV sync input thresholds from 0.9-V to 2-V range.  |



#### **TYPICAL CHARACTERISTICS**

3.3 V Graphs



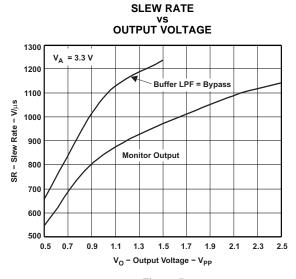
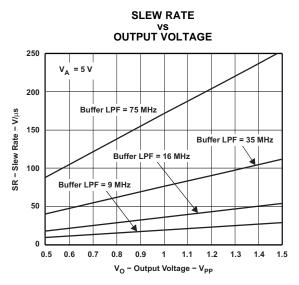
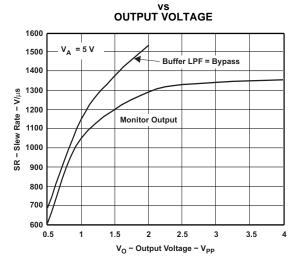


Figure 5.

#### **TYPICAL CHARACTERISTICS**

5 V Graphs





**SLEW RATE** 

Figure 6.

Figure 7.



#### **APPLICATION INFORMATION**

The THS7327 is targeted for RGB + HV sync video buffer applications. Although it can be used for numerous other applications, the needs and requirements of the video signal is the most important design parameter of the THS7327. Built on the complimentary Silicon Germanium (SiGe) BiCom-3 process, the THS7327 incorporates many features not typically found in integrated video parts while consuming low power. Each channel configuration is completely independent of the other channels. This allows for ANY configuration for each channel to be dictated by the end user rather than the device — resulting in a highly flexible system. The THS7327 has the following features:

- I<sup>2</sup>C Interface for easy interfacing to the system
- Single-supply 2.7-V to 5-V operation with low quiescent current of 100-mA at 3.3-V
- 2:1 input MUX
- Input configuration accepting dc, dc + shift, ac bias, or ac sync-tip clamp selection.
- Unity Gain Buffer path to drive ADC/Scalar/Decoder.
- Selectable 5<sup>th</sup>-order low-pass filter on buffer path for DAC reconstruction or ADC image rejection:
  - 9-MHz for SDTV NTSC and 480i, PAL/SECAM and 576i, and S-Video signals.
  - 16-MHz for EDTV 480p and 576p Y'P'<sub>B</sub>P'<sub>R</sub> signals and R'G'B' (G'B'R') VGA signals.
  - 35-MHz for HDTV 720p and 1080i Y'P'<sub>B</sub>P'<sub>R</sub> signals and R'G'B' SVGA and XGA signals.
  - 75-MHz for HDTV 1080p and R'G'B' SXGA signals.
  - Bypass mode for passing R'G'B' UXGA, QXGA or higher signals.
- Monitor Pass-thru path has an internal fixed gain of 2V/V (6 dB) amplifier that can drive 2 video lines with dc coupling, traditional ac coupling, or SAG corrected ac coupling.
- While disabled, the Monitor Pass-Thru path has a high output impedance (>500 kΩ || 8 pF)
- Power Up Control (PUC) allows the THS7327 to be fully disabled or have the Monitor Pass-Thru function (with AC-Bias mode on all channels) enabled upon initial power-up.
- MUX is controlled by either I<sup>2</sup>C or GPIO pin based on the MUX Mode pin logic.
- H and V Sync paths have an externally adjustable Schmitt Trigger threshold
- Disable mode which reduces guiescent current to as low as 0.1-µA.

#### **OPERATING VOLTAGE**

The THS7327 is designed to operate from 2.7 V to 5 V over a -40°C to 85°C temperature range. The impact on performance over the entire temperature range is negligible due to the implementation of thin film resistors and low-temperature coefficient capacitors.

The power supply pins should have a 0.1- $\mu$ F to 0.01- $\mu$ F capacitor placed as close as possible to these pins. Failure to do so may result in the THS7327 outputs ringing or oscillating. Additionally, a large capacitor, such as 22  $\mu$ F to 100  $\mu$ F, should be placed on the power supply line to minimize issues with 50-Hz/60-Hz line frequencies.

#### **INPUT VOLTAGE**

The THS7327 input range allows for an input signal range from ground to about ( $V_S+$  - 1.6 V). But, due to the internal fixed gain of 2V/V (6 dB), the output is generally the limiting factor for the allowable linear input range. For example, with a 5-V supply, the linear input range is from GND to 3.4 V. But due to the gain, the linear output range limits the allowable linear input range to be from GND to at most 2.5 V.



#### INPUT OVERVOLTAGE PROTECTION

The THS7327 is built using a high-speed complementary bipolar and CMOS process. The internal junction breakdown voltages are relatively low for these very small geometry devices. These breakdowns are reflected in the Absolute Maximum Ratings table. All input and output device pins are protected with internal ESD protection diodes to the power supplies, as shown in Figure 8.

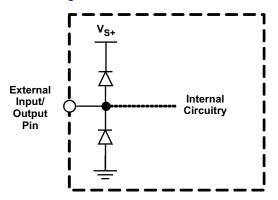


Figure 8. Internal ESD Protection

These diodes provide moderate protection to input overdrive voltages above and below the supplies. The protection diodes can typically support 30-mA of continuous current when overdriven.

#### TYPICAL CONFIGURATION

The THS7327 is typically used as a video buffer driving a video ADC (such as the TVP7001) with 0dB gain and the monitor output path drives an output line with 6-dB gain along with horizontal (H) and vertical (V) sync signals. The versatility of the THS7327 allows virtually any video signal to be utilized. This includes standard-definition (SD), enhanced-definition (ED), and high-definition (HD) Y'P'BP'R (sometimes labeled Y'U'V' or incorrectly labeled Y'C'BC'R) signals, S-Video Y'/C' signals, and the composite video baseband signal (CVBS) of a SD video system. These signals can also be R'G'B' (or G'B'R') or other variations on the placement of the sync signals commonly called R'G'sB' (sync on Green) or R'sG'sB's (sync on all signals). Additionally, the THS7327 handles the digital H and V sync signals with the noise immunity enhancement of a schmitt trigger. This schmitt trigger defaults to 1.45V, but can be set externally to be anywhere form 0.9V to 2.0V for added flexibility.

Simple control of the I<sup>2</sup>C configures the THS7327 for any configuration conceivable. For example, the THS7327 can be configured to have Channel 1 Input connected to input A while Channels 2 and 3 could be connected to input B. See the multiple application notes sections explaining the I<sup>2</sup>C interface later in this document on how to configure these options.

Note that the Y' term is used for the luma channels throughout this document rather than the more common luminance (Y) term. This is to account for the true definition of luminance as stipulated by the CIE - International Commission on Illumination. Video departs from true luminance since a nonlinear term, gamma, is added to the true RGB signals to form R'G'B' signals. These R'G'B' signals are then used to mathematically create luma (Y'). Thus true luminance (Y) is not maintained and hence the difference in terminology.

This rationale is also used for the chroma (C') term. Chroma is derived from the non-linear R'G'B' terms and thus it is non-linear. True chominance (C) is derived from linear RGB and hence the difference between chroma (C') and chrominance (C). The color difference signals  $(P'_B/P'_R/U'/V')$  are also referenced this way to denote the non-linear (gamma corrected) signals.

R'G'B' (commonly mislabeled RGB) is also called G'B'R' (again commonly mislabeled as GBR) in professional video systems. The SMPTE component standard stipulates that the luma information is placed on the first channel, the blue color difference is placed on the second channel, and the red color difference signal is placed on the third channel. This is consistent with the Y'P'<sub>B</sub>P'<sub>R</sub> nomenclature. Because the luma channel (Y') carries the sync information and the green channel (G') also carries the sync information, it makes logical sense that G'



be placed first in the system. Since the blue color difference channel  $(P'_B)$  is next and the red color difference channel  $(P'_R)$  is last, then it also makes logical sense to place the B' signal on the second channel and the R' signal on the third channel respectfully. Thus hardware compatibility is better achieved when using G'B'R' rather than R'G'B'. Note that for many G'B'R' systems sync is embedded on all three channels, but may not always be the case in all systems.

### I<sup>2</sup>C INTERFACE NOTES

The I<sup>2</sup>C interface is used to access the internal registers of the THS7327. I<sup>2</sup>C is a two-wire serial interface developed by Philips Semiconductor (see the I<sup>2</sup>C-Bus Specification, Version 2.1, January 2000). The bus consists of a data line (SDA) and a clock line (SCL) with pull-up structures. When the bus is idle, both SDA and SCL lines are pulled high. All the I<sup>2</sup>C compatible devices connect to the I<sup>2</sup>C bus through open drain I/O pins, SDA and SCL. A *master* device, usually a microcontroller or a digital signal processor, controls the bus. The master is responsible for generating the SCL signal and device addresses. The master also generates specific conditions that indicate the START and STOP of data transfer. A *slave* device receives and/or transmits data on the bus under control of the master device. The THS7327 works as a slave and supports the standard mode transfer (100 kbps) and fast mode transfer (400 kbps) as defined in the I<sup>2</sup>C-Bus specification. The THS7327 has been tested to be fully functional with the high-speed mode (3.4 Mbps) but it is **not** guaranteed at this time.

The basic I<sup>2</sup>C start and stop access cycles are shown in Figure 9.

The basic access cycle consists of the following:

- A start condition
- A slave address cycle
- · Any number of data cycles
- A stop condition

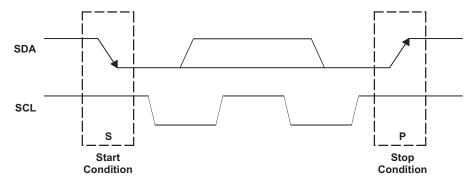


Figure 9. I<sup>2</sup>C Start and Stop Conditions

#### GENERAL I<sup>2</sup>C PROTOCOL

- The *master* initiates data transfer by generating a *start condition*. The *start condition* exist when a high-to-low transition occurs on the SDA line while SCL is high, as shown in Figure 9. All I<sup>2</sup>C-compatible devices should recognize a *start condition*.
- The master then generates the SCL pulses and transmits the 7-bit address and the *read/writedirection bit* R/W on the SDA line. During all transmissions, the master ensures that data is *valid*. A *valid data* condition requires the SDA line to be stable during the entire high period of the clock pulse (see Figure 10). All devices recognize the address sent by the master and compare it to their internal fixed addresses. Only the slave device with a matching address generates an *acknowledge* (see Figure 11) by pulling the SDA line low during the entire high period of the ninth SCL cycle. On detecting this acknowledge, the master knows that a communication link with a slave has been established.
- The master generates further SCL cycles to either *transmit* data to the slave (R/W bit 1) or *receive* data from the slave (R/W bit 0). In either case, the *receiver* needs to acknowledge the data sent by the *transmitter*. So, an acknowledge signal can either be generated by the master or by the slave, depending on which one is the receiver. The 9-bit valid data sequences consisting of 8-bit data and 1-bit acknowledge can continue as long as necessary (see Figure 12).



To signal the end of the data transfer, the master generates a *stop condition* by pulling the SDA line from low to high while the SCL line is high (see Figure 9). This releases the bus and stops the communication link with the addressed slave. All I<sup>2</sup>C compatible devices must recognize the *stop condition*. Upon the receipt of a stop condition, all devices know that the bus is released, and they wait for a *start condition* followed by a matching address.

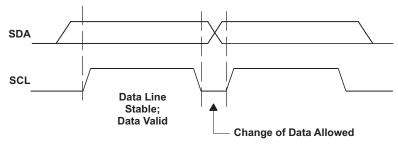


Figure 10. I<sup>2</sup>C Bit Transfer

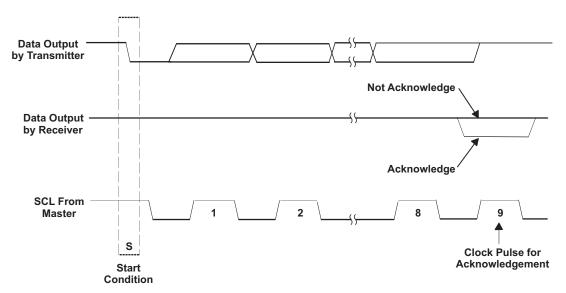


Figure 11. I<sup>2</sup>C Acknowledge

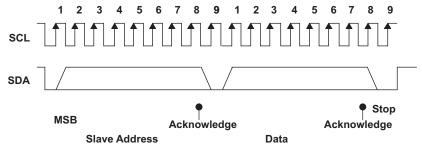


Figure 12. I<sup>2</sup>C Address and Data Cycles



During a write cycle, the transmitting device must not drive the SDA signal line during the acknowledge cycle, so that the receiving device may drive the SDA signal low. After each byte transfer following the address byte, the receiving device pulls the SDA line low for one SCL clock cycle. A stop condition is initiated by the transmitting device after the last byte is transferred. An example of a write cycle can be found in Figure 13 and Figure 14. Note that the THS7327 does not allow multiple write transfers to occur. See **Example – Writing to the THS7327**section for more information.

During a read cycle, the slave receiver acknowledges the initial address byte if it decodes the address as its address. Following this initial acknowledge by the slave, the master device becomes a receiver and acknowledges data bytes sent by the slave. When the master has received all of the requested data bytes from the slave, the not acknowledge (A) condition is initiated by the master by keeping the SDA signal high just before it asserts the stop (P) condition. This sequence terminates a read cycle as shown in Figure 15 and Figure 16. Note that the THS7327 does not allow multiple read transfers to occur. See **Example – Reading from the THS7327** section for more information.

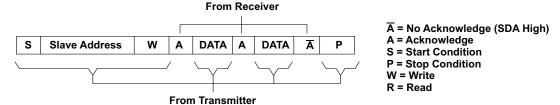


Figure 13. I<sup>2</sup>C Write Cycle

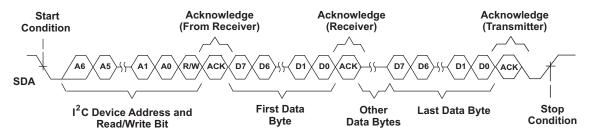


Figure 14. Multiple Byte Write Transfer

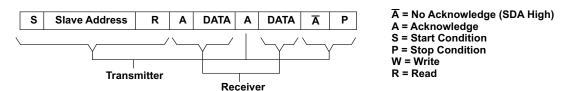


Figure 15. I<sup>2</sup>C Read Cycle

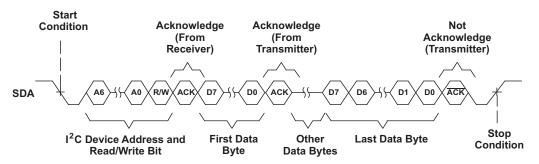


Figure 16. Multiple Byte Read Transfer



#### Slave Address

Both the SDA and the SCL must be connected to a positive supply voltage via a pullup resistor. These resistors should comply with the  $I^2C$  specification that ranges from 2 k $\Omega$  to 19 k $\Omega$ . When the bus is free, both lines are high. The address byte is the first byte received following the START condition from the master device. The first 5 Bits (MSBs) of the address are factory preset to 01011. The next two bits of the THS7327 address are controlled by the logic levels appearing on the  $I^2C$ -A1 and  $I^2C$ -A0 pins. The  $I^2C$ -A1 and  $I^2C$ -A0 address inputs can be connected to  $V_{S+}$  for logic 1, GND for logic 0, or it can be actively driven by TTL/CMOS logic levels. The device address is set by the state of these pins and is not latched. Thus, a dynamic address control system could be used to incorporate several devices on the same system. Up to four THS7327 devices can be connected to the same  $I^2C$ -Bus without requiring additional *glue* logic. Table 1 lists the possible addresses for the THS7327.

SELECTABLE WITH READ/WRITE **FIXED ADDRESS ADDRESS PINS** BIT Bit 7 (MSB) Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 (A1) Bit 1 (A0) Bit 0 

Table 1. THS7327 Slave Addresses

#### Channel Selection Register Description (Subaddress) and Power-Up Condition (PUC) Pin

The THS7327 operates using only a single byte transfer protocol similar to Figure 13 and Figure 15. The internal subaddress registers and the functionality of each are found in Table 2. When writing to the device, it is required to send one byte of data to the corresponding internal subaddress. If control of all three channels is desired, then the master has to cycle through all the subaddresses (channels) one at a time, see the **Example – Writing to the THS7327** section for the proper procedure of writing to the THS7327.

During a read cycle, the THS7327 sends the data in its selected subaddress (or channel) in a single transfer to the master device requesting the information. See the **Example – Reading from the THS7327** section for the proper procedure on reading from the THS7327.

On power up, the THS7327 registers are dictated by the power-up control (PUC) pin. If the PUC pin is tied to GND, the THS7327 will power-up in a fully disabled state. If the PUC pin is tied to VDD, upon power-up the THS7327 will be configured with HV sync on, buffer path disabled, monitor path Enabled, and input bias mode set to AC-Bias on all input channels. It remains in this state until a valid write sequence is made to the THS7327. A total of 12 bytes of data completely configures all channels of the THS7327. As such, configuring the THS7327 is accomplished quickly and easily.

Table 2. THS7327 Channel Selection Register Bit Assignments

| REGISTER NAME                             | BIT ADDRESS<br>(b <sub>7</sub> b <sub>6</sub> b <sub>5</sub> b <sub>0</sub> ) |
|---|---|
| Channel 1                                 | 0000 0001   |
| Channel 2                                 | 0000 0010   |
| Channel 3                                 | 0000 0011   |
| Channel H and V Sync and Disable Controls | 0000 0100   |



#### **Channel Register Bit Descriptions**

Each bit of the subaddress (channel selection) control register as described above allows the user to individually control the functionality of the THS7327. The benefit of this process allows the user to control the functionality of each channel independent of the other channels. The bit description is decoded in Table 3 and Table 4.

Table 3. THS7327 Channel Register (Ch. 1 thru 3) Bit Decoder Table – Use with Register Bit Codes (0000 0001), (0000 0010), and (0000 0011)

| BIT        | FUNCTION              | BIT<br>VALUE(S) | RESULT   |
|------------|-----------------------|-----------------|--|
| (MSB)      | Sync-Tip Clamp Filter | 0               | 500-kHz Filter on the STC circuit                    |
| 7          | Sync-rip Clamp Filter | 1               | 5-MHz Filter on the STC circuit                      |
|            |                       | 0000            | MUX Input A; LPF = 9-MHz                             |
|            |                       | 0 0 0 1         | MUX Input A; LPF = 16-MHz                            |
|            |                       | 0010            | MUX Input A; LPF = 35-MHz                            |
|            |                       | 0 0 1 1         | MUX Input A; LPF = 75-MHz                            |
|            |                       | 0100            | MUX Input A; LPF = Bypass                            |
|            |                       | 0101            | MUX Input B; LPF = 9-MHz                             |
|            |                       | 0110            | MUX Input B; LPF = 16-MHz                            |
| 6, 5, 4, 3 | MUX Selection         | 0 1 1 1         | MUX Input B; LPF = 35-MHz                            |
| 0, 5, 4, 3 | +<br>Low Pass Filter  | 1000            | MUX Input B; LPF = 75-MHz                            |
|            |                       | 1001            | MUX Input B; LPF = Bypass                            |
|            |                       | 1010            | Reserved – Do Not Care                               |
|            |                       | 1011            | Reserved – Do Not Care                               |
|            |                       | 1100            | Reserved – Do Not Care                               |
|            |                       | 1 1 0 1         | Reserved – Do Not Care                               |
|            |                       | 1110            | Reserved – Do Not Care                               |
|            |                       | 1111            | Reserved – Do Not Care                               |
|            |                       | 0 0 0           | Disable Channel if Register 4 bit is 0 - see Table 4 |
|            |                       | 0 0 1           | Channel Mute   |
|            |                       | 0 1 0           | Input Mode = DC                                      |
| 2, 1, 0    | Input Mode<br>+       | 0 1 1           | Input Mode = DC + Shift                              |
| (LSB)      | Operation             | 100             | Input Mode = AC-Bias                                 |
|            |                       | 1 0 1           | Input Mode = AC-STC with Low Bias                    |
|            |                       | 110             | Input Mode = AC-STC with Mid Bias                    |
|            |                       | 111             | Input Mode = AC-STC with High Bias                   |

Bits 7 (MSB) – Controls the sync-tip clamp filter. Useful only when AC-STC input mode is selected.

Bit 6, 5, 4, 3 – Selects the Input MUX channel and the Buffer low pass filter

Bits 2, 1, and 0 (LSB) – Configures the channel mode and operation. For the disable code (000), the monitor path channel is in disabled state. The Buffer path state is disabled if Register 4, bit 0 is set to 0. If Register 4, bit 0 is set to 1, then the Buffer path is enabled while the monitor path is disabled.



## Table 4. THS7327 Channel Register (HV Sync Channel + ADC State) Bit Decoder Table – Use in Conjunction With Register Bit Code (0000 0100)

| BIT        | FUNCTION                              | BIT<br>VALUE(S)                               | RESULT   |  |  |  |  |  |
|------------|---------------------------------------|---|--|--|--|--|--|--|
| (MSB)<br>7 | Reserved – Do Not Care                | Х   | Reserved – Do Not Care                                 |  |  |  |  |  |
| 6          | Monitor Pass-Thru Path Disable Mode 0 |   | Disable Monitor Channel if Ch. 1-3 bits 2,1,0 = 000    |  |  |  |  |  |
| 6          | (Use in Conjunction with Table 3)     | 1   | Enable Monitor Channel 1-3 bits 2,1,0 = 000            |  |  |  |  |  |
| 5          | Buffer Path Disable Mode (Use in      | 0   | Disable Buffer Channel if Channel 1-3 bits 2,1,0 = 000 |  |  |  |  |  |
| 5          | Conjunction with Table 3)             |   | Enable Buffer Channel if Channel 1-3 bits 2,1,0 = 000  |  |  |  |  |  |
|            |                                       | 0 0   | MUX Input A  |  |  |  |  |  |
| 4.2        | Vertical Sync Channel MUX Selection   | 0 1   | MUX Input B  |  |  |  |  |  |
| 4, 3       |                                       | 1 0   | Reserved – Do Not Care                                 |  |  |  |  |  |
|            |                                       | 1 1   | Reserved – Do Not Care                                 |  |  |  |  |  |
|            |                                       | 0 0   | MUX Input A  |  |  |  |  |  |
| 0.4        | Horizontal Sync Channel MUX           | 0 1   | MUX Input B  |  |  |  |  |  |
| 2, 1       | Selection                             | 1 0   | Reserved – Do Not Care                                 |  |  |  |  |  |
|            |                                       | 1 1   | Reserved – Do Not Care                                 |  |  |  |  |  |
| 0          | LIV Syna Datha Diaghla Mada           | 0   | Disable H and V Sync Channels (all channels)           |  |  |  |  |  |
| (LSB)      | HV Sync Paths Disable Mode            | 1 Enable H and V Sync Channels (all channels) |  |  |  |  |  |  |

Bit (MSB) 7 - Reserved - Do Not Care

Bit 6 – Enables or Disables the Respective Monitor Channel if Registers Ch. 1 (0000 0001), Ch. 2 (0000 0010), and/or Ch.3 (0000 0011) are set to the Disable State (XXXX X000).

Bit 5 – Enables or Disables the Respective Buffer Channel if Registers Ch. 1 (0000 0001), Ch. 2 (0000 0010), and/or Ch.3 (0000 0011) are set to the Disable State (XXXX X000).

Bits 4, 3 – Selects the Input MUX channel for the Vertical Sync

Bits 2, 1 – Selects the Input MUX channel for the Horizontal Sync

Bit 0 (LSB) - Configures the Buffer path Enable/Disable state when used in conjunction with Table 3.



#### **EXAMPLE – WRITING TO THE THS7327**

The proper way to write to the THS7327 is illustrated as follows:

An I<sup>2</sup>C master initiates a write operation to the THS7327 by generating a start condition (S) followed by the THS7327 I<sup>2</sup>C address (as shown below), in MSB first bit order, followed by a 0 to indicate a write cycle. After receiving an acknowledge from the THS7327, the master presents the subaddress (channel) it wants to write consisting of one byte of data, MSB first. The THS7327 acknowledges the byte after completion of the transfer. Finally the master presents the data it wants to write to the register (channel) and the THS7327 acknowledges the byte. The I<sup>2</sup>C master then terminates the write operation by generating a stop condition (P). Note that the THS7327 does not support multi-byte transfers. To write to all three channels – or registers – this procedure must be repeated for each register one series at a time (i.e., repeat steps 1 through 8 for each channel).

| Step 1                                    | ) |   |   |   |   |   |   |   |  |
|---|---|---|---|---|---|---|---|---|--|
| I <sup>2</sup> C Start (Master)           | S |   |   |   |   |   |   |   |  |
| Step 2                                    | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |  |
| I <sup>2</sup> C General Address (Master) | 0 | 1 | 0 | 1 | 1 | Х | Х | 0 |  |

Where each X Logic state is defined by I<sup>2</sup>C-A1 and I<sup>2</sup>C-A0 pins being tied to either Vs+ or GND.

| Step 3  | 9 |   |   |   |   |      |      |      |  |
|---|---|---|---|---|---|------|------|------|--|
| I <sup>2</sup> C Acknowledge (Slave)            | Α |   |   |   |   |      |      |      |  |
| Step 4  | 7 | 6 | 5 | 4 | 3 | 2    | 1    | 0    |  |
| I <sup>2</sup> C Write Channel Address (Master) | 0 | 0 | 0 | 0 | 0 | Addr | Addr | Addr |  |

Where Addr is determined by the values shown in Table 2.

| Step 5                               | 9    |      |      |      |      |      |      |      |
|--------------------------------------|------|------|------|------|------|------|------|------|
| I <sup>2</sup> C Acknowledge (Slave) | A    |      |      |      |      |      |      |      |
| Step 6                               | 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
| I <sup>2</sup> C Write Data (Master) | Data |

Where Data is determined by the values shown in Table 3 or Table 4.

| Step 7                               | 9 |
|--------------------------------------|---|
| I <sup>2</sup> C Acknowledge (Slave) | A |
| Step 8                               | 0 |
| I <sup>2</sup> C Stop (Master)       | P |



#### **EXAMPLE – READING FROM THE THS7327**

The read operation consists of two phases. The first phase is the address phase. In this phase, an I<sup>2</sup>C master initiates a write operation to the THS7327 by generating a start condition (S) followed by the THS7327 I<sup>2</sup>C address, in MSB first bit order, followed by a 0 to indicate a write cycle. After receiving acknowledges from the THS7327, the master presents the subaddress (channel) of the register it wants to read. After the cycle is acknowledged (A), the master terminates the cycle immediately by generating a stop condition (P).

The second phase is the data phase. In this phase, an I<sup>2</sup>C master initiates a read operation to the THS7327 by generating a start condition followed by the THS7327 I<sup>2</sup>C address (as shown below for a read operation), in MSB first bit order, followed by a 1 to indicate a read cycle. After an acknowledge from the THS7327, the I<sup>2</sup>C master receives one byte of data from the THS7327. After the data byte has been transferred from the THS7327 to the master, the master generates a not acknowledge followed by a stop. Similar to the Write function, to read all channels Steps 1 through 11 must be repeated for each and every channel desired.

#### THS7327 Read Phase 1:

| Step 1                                    | 0 | 0 |   |   |   |   |   |   |  |  |  |
|---|---|---|---|---|---|---|---|---|--|--|--|
| I <sup>2</sup> C Start (Master)           | S |   |   |   |   |   |   |   |  |  |  |
| Step 2                                    | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |  |  |  |
| I <sup>2</sup> C General Address (Master) | 0 | 1 | 0 | 1 | 1 | Х | Х | 0 |  |  |  |

Where each X Logic state is defined by  $I^2C-A1$  and  $I^2C-A0$  pins being tied to either  $V_{S+}$  or GND.

| Step 3   | 9 |   |   |   |   |      |      |      |  |
|--|---|---|---|---|---|------|------|------|--|
| I <sup>2</sup> C Acknowledge (Slave)           | Α |   |   |   |   |      |      |      |  |
| Step 4   | 7 | 6 | 5 | 4 | 3 | 2    | 1    | 0    |  |
| I <sup>2</sup> C Read Channel Address (Master) | 0 | 0 | 0 | 0 | 0 | Addr | Addr | Addr |  |

Where Addr is determined by the values shown in Table 2.

| Step 5                               | 9 |
|--------------------------------------|---|
| I <sup>2</sup> C Acknowledge (Slave) | A |
| Step 6                               | 0 |
| I <sup>2</sup> C Start (Master)      | P |

#### THS7327 Read Phase 2:

| Step 7                                    | 0 |   |   |   |   |   |   |   |  |
|---|---|---|---|---|---|---|---|---|--|
| I <sup>2</sup> C Start (Master)           | S |   |   |   |   |   |   |   |  |
| Step 8                                    | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |  |
| I <sup>2</sup> C General Address (Master) | 0 | 1 | 0 | 1 | 1 | Х | Х | 1 |  |

Where each X Logic state is defined by I<sup>2</sup>C-A1 and I<sup>2</sup>C-A0 pins being tied to either V<sub>S+</sub> or GND.

| Step 9                               | 9    |      |      |      |      |      |      |      |
|--------------------------------------|------|------|------|------|------|------|------|------|
| I <sup>2</sup> C Acknowledge (Slave) | A    |      |      |      |      |      |      |      |
| Step 10                              | 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
| I <sup>2</sup> C Read Data (Slave)   | Data |

Where Data is determined by the Logic values contained in the Channel Register.

| Step 11                                   | 9              |
|---|----------------|
| I <sup>2</sup> C Not-Acknowledge (Master) | $\overline{A}$ |
| Ston 40                                   |                |
| Step 12                                   | 0              |
| I <sup>2</sup> C Stop (Master)            | Р              |



#### PACKAGE OPTION ADDENDUM

23-Oct-2006

#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup>    | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| THS7327PHP       | ACTIVE                | HTQFP           | PHP                | 48   | 250            | Green (RoHS & no Sb/Br)    | NIPDAU CU        | Level-3-260C-168 HR          |
| THS7327PHPG4     | ACTIVE                | HTQFP           | PHP                | 48   | 250            | Green (RoHS & no Sb/Br)    | NIPDAU CU        | Level-3-260C-168 HR          |
| THS7327PHPR      | ACTIVE                | HTQFP           | PHP                | 48   | 1000           | Green (RoHS & no Sb/Br)    | NIPDAU CU        | Level-3-260C-168 HR          |
| THS7327PHPRG4    | ACTIVE                | HTQFP           | PHP                | 48   | 1000           | Green (RoHS &<br>no Sb/Br) | NIPDAU CU        | Level-3-260C-168 HR          |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

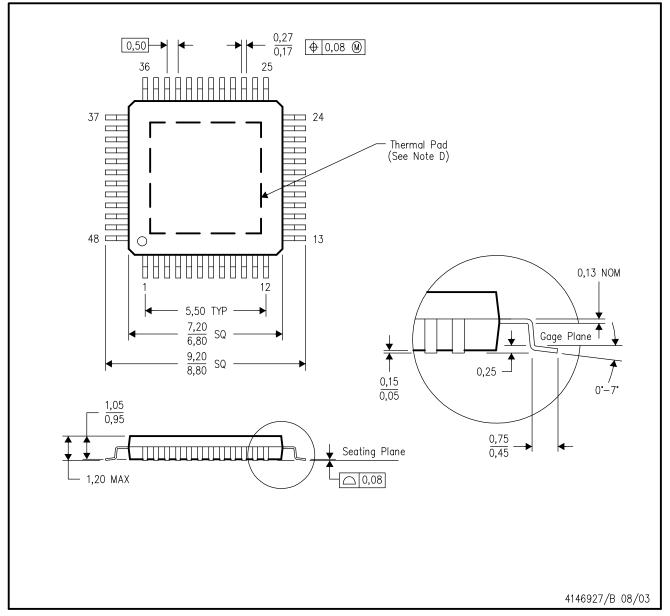
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## PHP (S-PQFP-G48)

## PowerPAD™ PLASTIC QUAD FLATPACK



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <a href="https://www.ti.com">www.ti.com</a>.
- E. Falls within JEDEC MS-026

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